

## N-Channel Enhancement Mode Power MOSFET

### Description

This Power MOSFET is produced using advanced SGT technology. This advanced technology has been especially tailored to minimize conduction loss, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode.

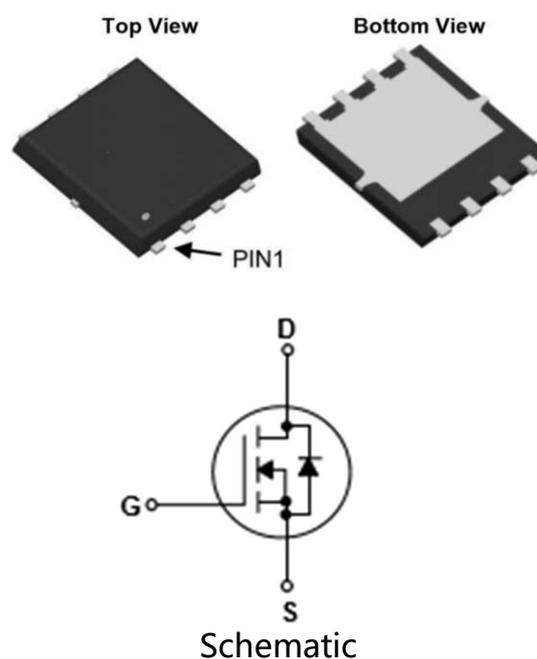
### Features

- $V_{DS}=30V$  ,  $I_D=178A$
- $R_{DS(ON) TYP} = 1.1m\Omega @V_{GS}=10V$
- $R_{DS(ON) TYP} = 2.1m\Omega @V_{GS}=4.5V$
- Very Low On-resistance  $R_{DS(ON)}$
- Low  $C_{rSS}$
- Fast switching
- 100% avalanche tested
- Improved  $dv/dt$  capability

### Applications

- Current Switch for DC/DC, AC/DC
- Power Management
- Motor Driving, Quick/Wireless Charging

PDFN5\*6-8L



### Absolute Maximum Ratings

Parameter		Symbol	Value	Unit
Drain-source Voltage		$V_{DS}$	30	V
Gate-source Voltage		$V_{GS}$	$\pm 20$	V
Continuous Drain Current	$T_C=25^{\circ}C$	$I_D$	178	A
	$T_C=100^{\circ}C$		110	
Pulsed Drain Current( $T_C=25^{\circ}C, T_p$ Limited By $T_{jmax}$ ) <sup>(note1)</sup>		$I_{DM}$	485	A
Maximum Power Dissipation( $T_C=25^{\circ}C$ )		$P_D$	78	W
Avalanche energy , single Pulse( $L=0.5mH$ ) <sup>(note2)</sup>		$E_{AS}$	101	mJ
Thermal Resistance Junction to Case		$R_{\theta JC}$	1.2	$^{\circ}C/W$
Thermal Resistance, Junction to Ambient		$R_{\theta JA}$	50	$^{\circ}C/W$
Operating Junction And Storage Temperature		$T_j, T_{stg}$	-55 To 150	$^{\circ}C$

\* Drain current limited by maximum junction temperature.

#### Notes:

1. This single-pulse measurement was taken under  $T_{j\_Max}=150^{\circ} C$
2. This Single-pulse measurement was taken under the following condition [ $L=100\mu H, V_{GS}=10V, V_{DS}=30V$ ] while its value is limited by  $T_{j\_Max}=150^{\circ} C$ .

**Electrical Characteristic (TC=25°C unless otherwise noted)**

Parameter	Symbol	Value			Unit	Test Condition
		Min.	Typ.	Max.		
<b>Off Characteristic</b>						
Drain-source breakdown voltage	$BV_{DSS}$	30	-	-	V	$V_{GS}=0V, I_D=1mA$
Zero gate voltage drain current	$I_{DSS}$	-	-	1	$\mu A$	$V_{DS}=30V, V_{GS}=0V$
		-	-	5	$\mu A$	$V_{DS}=30V, TC=55^\circ C$
Gate-source leakage current	$I_{GSS}$	-	-	$\pm 100$	nA	$V_{GS}=\pm 20V, V_{DS}=0V$
<b>On Characteristics</b>						
Gate threshold voltage	$V_{GS(th)}$	1.2	1.7	2.5	V	$V_{DS}=V_{GS}, I_D=250\mu A$
Drain-source on-state resistance	$R_{DS(on)}$	-	1.1	1.4	m $\Omega$	$V_{GS}=10V, I_D=20A$
Drain-source on-state resistance	$R_{DS(on)}$	-	2.1	2.8	m $\Omega$	$V_{GS}=4.5V, I_D=15A$
<b>Dynamic Characteristic</b>						
Input Capacitance	$C_{iss}$	-	2975	-	PF	$V_{GS}=0V, V_{DS}=15V, f=1.0MHz$
Output Capacitance	$C_{oss}$	-	2650	-		
Reverse Transfer Capacitance	$C_{rss}$	-	117	-		
Gate Resistance	$R_G$		1.4		$\Omega$	$V_{GS}=0V, V_{DS}=0V, f=1MHz$
<b>Switching Characteristics</b>						
Turn-on delay time	$t_{d(on)}$	-	6	-	nS	$V_{GS}=10V, V_{DS}=15V, RL=0.75\Omega, R_G=3\Omega$
Turn-on Rise time	$t_r$	-	9	-		
Turn-off delay time	$t_{d(off)}$	-	26			
Turn-off Fall time	$t_f$	-	10	-		
Gate Total Charge	$Q_G$	-	39	-	nC	$V_{GS}=10V, V_{DS}=15V, I_D=20A$
Gate-Source Charge	$Q_{gs}$	-	8.6	-		
Gate-Drain Charge	$Q_{gd}$	-	5.0	-		
<b>Drain-Source Diode Characteristics</b>						
Body Diode Forward Voltage	$V_{SD}$	-	0.68	1.0	V	$V_{GS}=0V, I_{SD}=1A, T_J=25^\circ C$
Body Diode Forward Current	$I_S$	-	-	78	A	-
Body Diode Reverse Recovery Time	$T_{rr}$	-	51	-	ns	$T_J=25^\circ C, I_F=20A,$
Body Diode Reverse Recovery Charge	$Q_{rr}$	-	57	-	nC	$D_{IF}/d_t=100A/\mu s$

## Typical Electrical & Thermal Characteristics

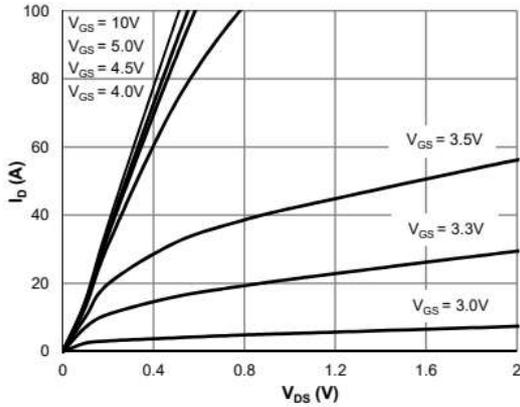


Figure 1: Saturation Characteristics

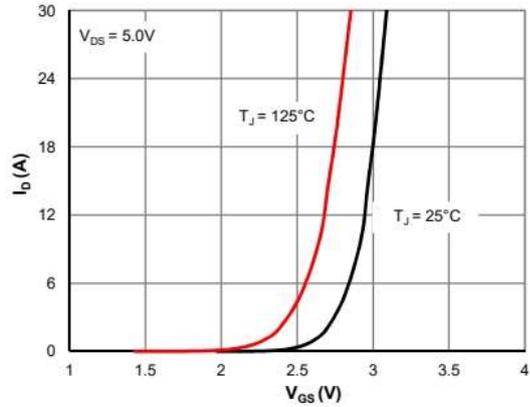


Figure 2: Transfer Characteristics

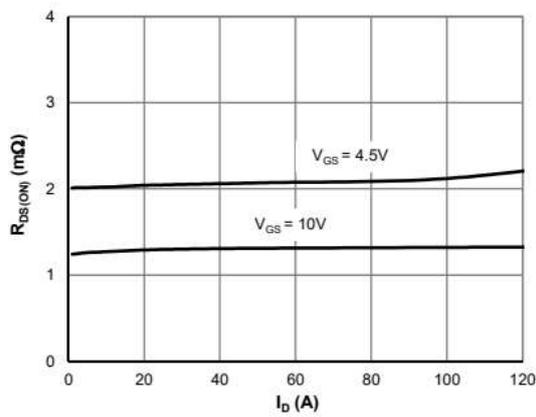


Figure 3:  $R_{DS(ON)}$  vs. Drain Current

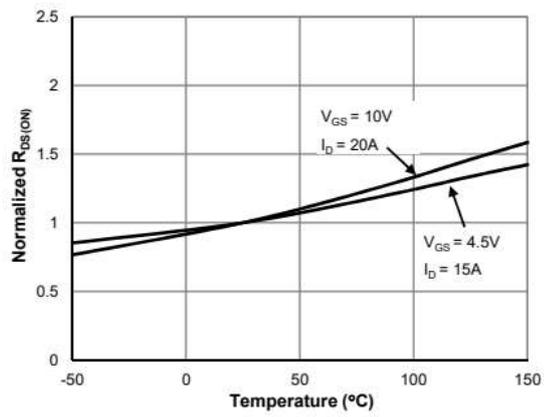


Figure 4:  $R_{DS(ON)}$  vs. Junction Temperature

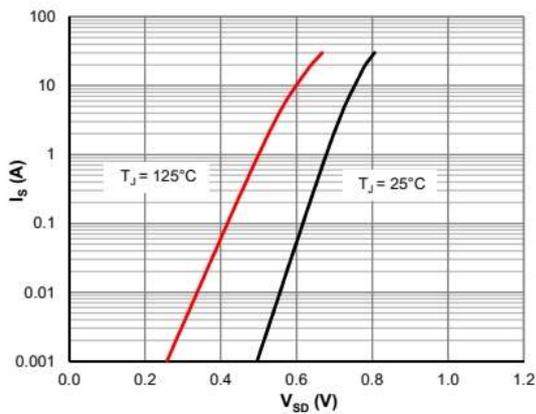


Figure 5: Body-Diode Characteristics

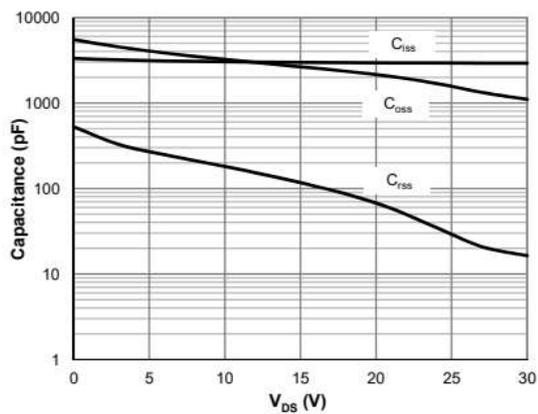


Figure 6: Capacitance Characteristics

## Typical Electrical & Thermal Characteristics

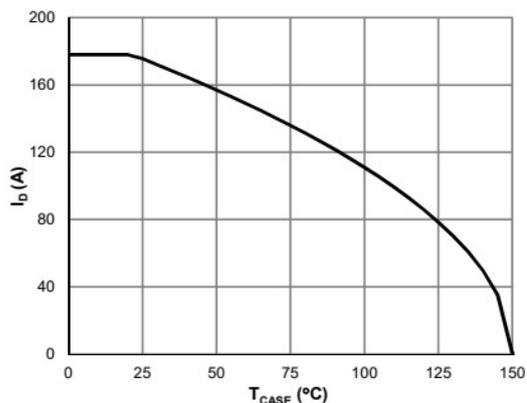


Figure 7: Current De-rating

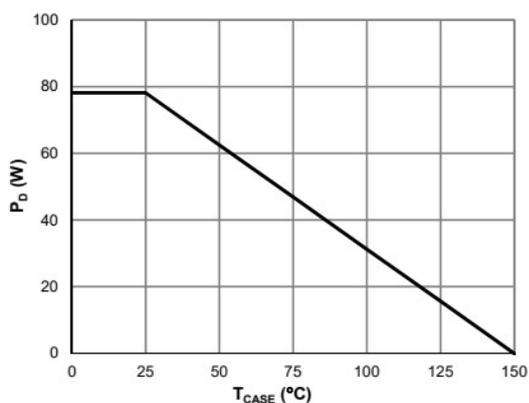


Figure 8: Power De-rating

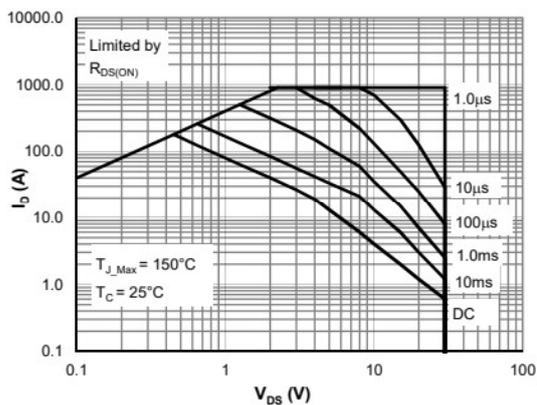


Figure 9: Maximum Safe Operating Area

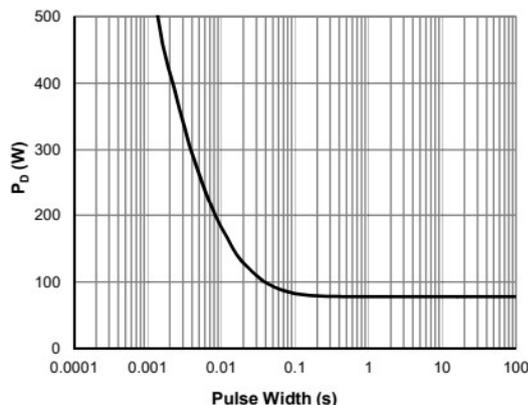


Figure 10: Single Pulse Power Rating, Junction-to-Case

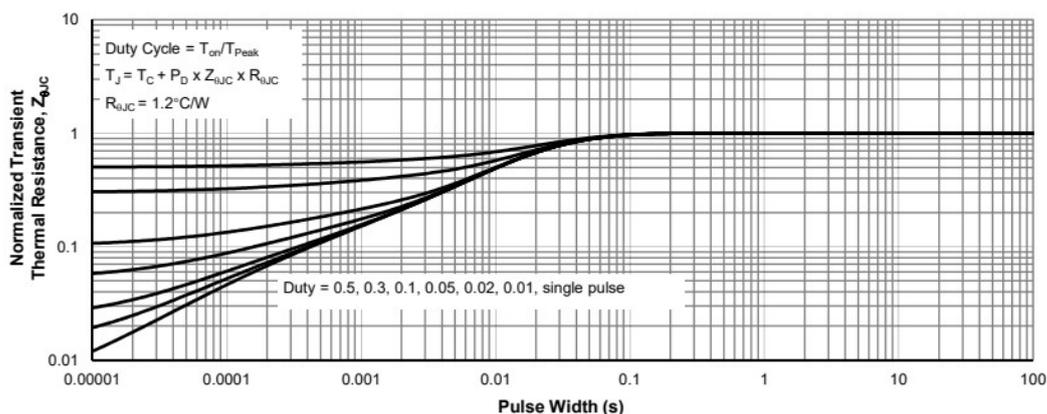
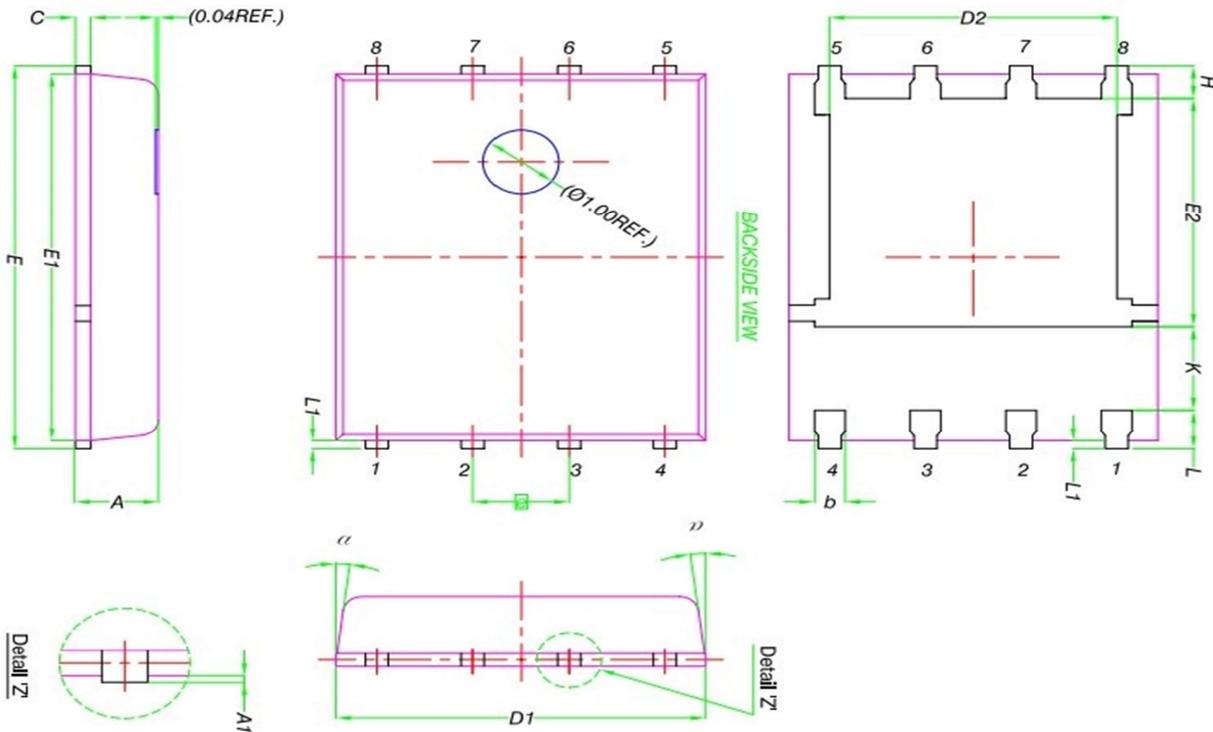


Figure 11: Normalized Maximum Transient Thermal Impedance

## Package Information

PDFN5\*6-8L



DIM.	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.90	1.00	1.10
A1	0	-	0.05
b	0.33	0.41	0.51
C	0.20	0.25	0.30
D1	4.80	4.90	5.00
D2	3.61	3.81	3.96
E	5.90	6.00	6.10
E1	5.70	5.75	5.80
E2	3.38	3.58	3.78
$e$	1.27 BSC		
H	0.41	0.51	0.61
K	1.10	-	-
L	0.51	0.61	0.71
L1	0.06	0.13	0.20
$\alpha$	0°	-	12°

Note:

